

EAST Search History (6 pp.)

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
S1	7	"812454".ap.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/08/06 19:22
S2	1	(US-20040245530-\$).did.	US-PGPUB	OR	OFF	2005/08/06 19:22
S3	0	2001-339151\$-\$ did.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/08/06 19:23
S4	2	jp-2001339151\$-\$ did.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/08/06 19:24
S5	157476	(light adj emitting light-emitting laser opto-electronic optoelectronic photo adj diode photodetector photodiode CCD CMOS adj imag\$3) and (desiccant water)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/08/06 20:15
S6	245	(257/682).CCLS.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/08/06 20:07
S7	22	S5 and S6	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/08/06 20:07
S8	38805	(light adj emitting light-emitting laser opto-electronic optoelectronic photo adj diode photodetector photodiode CCD CMOS adj imag\$3) and (desiccant moisture)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/08/06 20:16
S9	7096	(light adj emitting light-emitting laser opto-electronic optoelectronic photo adj diode photodetector photodiode CCD CMOS adj imag\$3) and (desiccant moisture damage near3 water).ti, ab,clm.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/08/06 20:16

EAST Search History

S10	2	S6 and S9	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/08/06 20:16
S11	2439	cover\$3 near20 (desicc\$3 moisture) and (light-emitting light adj emitting laser photodiode photodetector photodetecting CMOS adj imag\$3)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/08/07 12:57
S12	491	cover\$3 near20 (desicc\$3 moisture) near20 seal\$3 and (light-emitting light adj emitting laser photodiode photodetector photodetecting CMOS adj imag\$3)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/08/07 12:57
S13	74	cover\$3 near20 (desicc\$3 moisture) near20 seal\$3 near20 resin and (light-emitting light adj emitting laser photodiode photodetector photodetecting CMOS adj imag\$3)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/08/07 13:54
S14	105	cover\$3 near20 (desicc\$3 moisture) near20 seal\$3 near20 (epoxy resin thermoplastic thermosetting polyethylene terephthalate polypropylene polystyrene acrylic polyphenylene adj ether polyamide polycarbonate polyacetal polybutylene polyphenylene adj sulfide polyether adj ether adj ketone liquid adj crystal adj polymer fluororesin polyurethane adj resin elastomer urea phenol melamine furan alkyd polyester diallyl adj phthatale silicon adj resin polyurethane) and (light-emitting light adj emitting laser photodiode photodetector photodetecting CMOS adj imag\$3 charge adj couple\$1 charge-couple\$1 CCD CID)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/08/07 16:36
S15	22	S14 and cover\$3 near6 (side sides side adj surface)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/08/07 13:27

EAST Search History

S16	22	S14 and cover\$3 near6 (side sides side adj surface) and (resin epoxy seal\$3)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/08/07 13:29
S17	13	S14 and cover\$3 near12 (side sides side adj surface) near12 (resin epoxy seal\$3)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/08/07 13:29
S18	2	jp-11277089\$-\$ did.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/08/07 14:50
S19	2	jp-11277090\$-\$ did.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/08/07 14:50
S20	1	"11-277090"	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/08/07 15:11
S21	2	jp-2000173766\$-\$ did.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/08/07 15:11
S22	2	"6621143"	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/08/07 16:12
S23	2	("6621143").PN.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/08/07 16:13
S24	4	EP38 near4 resin	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/08/07 16:59
S25	0	bump adj: electrode near6 counter adj: electrode and (light-emitting light adj: emitting laser).ti,ab,clm.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/08/07 16:59

EAST Search History

S26	2	bump near6 counter adj electrode and (light-emitting light adj emitting laser).ti,ab,clm.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/08/07 17:09
S27	2282	bump.ti,ab,clm. and (light-emitting light adj emitting laser).ti,ab,clm.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/08/07 17:10
S28	3	bump.ti,ab,clm. and (light-emitting light adj emitting laser).ti,ab,clm. and bump near4 (counter adj electrode)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/08/07 17:11
S29	341	stud adj bump near4 (technique method)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/08/07 17:12
S30	74	stud adj bump near4 (technique method).ti,ab,clm.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/08/07 17:12
S31	6538	((257/81) or (257/99) or (257/100) or (257/428) or (257/431) or (257/432) or (257/433)).CCLS.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/08/07 19:27
S32	146	S31 and (moisture desiccant) and seal\$3 and transparent near4 (substrate cover)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/04/27 16:39
S33	360	S31 and seal\$3 and transparent near4 (substrate cover)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/08/07 18:18
S34	214	S33 not S32	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/08/07 18:38
S35	2	("20010018236").PN.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/08/07 18:52

EAST Search History

S36	0	("su-8adjphotoresistnear6transparent").PN.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/08/07 18:52
S37	3	su-8 adj photoresist near6 transparent	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/08/07 18:53
S38	1	(US-20040245530-\$).did.	US-PGPUB	OR	OFF	2006/01/15 21:22
S39	2	jp-2000173766\$-\$ did.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/15 21:23
S40	3	("6833668").PN.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/01/15 21:24
S41	2	("20010018236").PN.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/01/15 22:14
S42	3	("2001018236").PN.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/04/27 13:29
S43	2	("20010018236").PN.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/04/27 13:54
S44	2	jp-2000173766\$-\$ did.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/04/27 13:54
S45	3	("6833668").PN.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/04/27 14:49

EAST Search History

S46	3	(("20020081838") or ("6671947")).PN.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/04/27 14:49
S47	7364	((257/81) or (257/99) or (257/100) or (257/428) or (257/431) or (257/432) or (257/433) or (257/682)).CCLS.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/04/27 16:38
S48	177	S47 and (moisture desiccant) and seal\$3 and transparent near4 (substrate cover)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/04/27 16:39
S49	7109	((257/81) or (257/99) or (257/100) or (257/428) or (257/431) or (257/432) or (257/433)).CCLS.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/04/27 16:39
S50	173	S49 and (moisture desiccant) and seal\$3 and transparent near4 (substrate cover)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/04/27 16:40
S51	4	S48 not S50	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/04/27 16:40